



## SSCL9DN40GN6

### Dual N-Channel Enhancement Mode MOSFET

#### ➤ Features

$V_{DS}$	$V_{GS}$	$R_{DS(ON)}$ Typ.	$I_D$
40V	$\pm 20V$	9m $\Omega$ @10V	54A
		12m $\Omega$ @4.5V	

#### ➤ Description

This device is N-Channel enhancement MOSFET. Uses SGT technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit.

**100% UIS +  $\Delta V_{DS}$  +  $R_g$  Tested!**

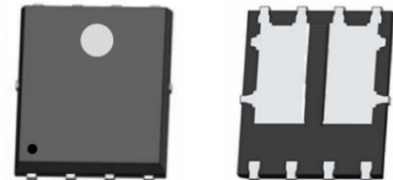
#### ➤ Applications

- Motor Drive Control
- DCDC Conversion
- Power Supplies
- Synchronous Rectification

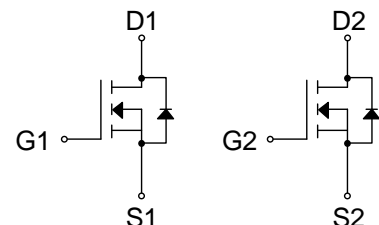
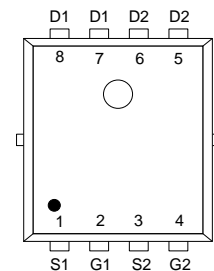
#### ➤ Ordering Information

Device	Package	Shipping
SSCL9DN40GN6	PDFN5X6-8L	5000/Reel

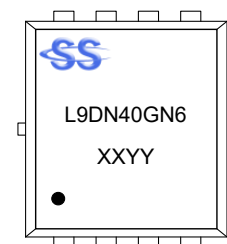
#### ➤ Pin Configuration



**PDFN5X6-8L**



**Pin Configuration (Top View)**



**Marking**

(XYYY: Internal Traceability Code)

**➤ Absolute Maximum Ratings ( $T_A=25^{\circ}\text{C}$  unless otherwise noted)**

Symbol	Parameter		Ratings	Unit
$V_{DSS}$	Drain-to-Source Voltage		40	V
$V_{GSS}$	Gate-to-Source Voltage		$\pm 20$	V
$I_D$	Continuous Drain Current <sup>d</sup>	$T_C=25^{\circ}\text{C}$	54	A
		$T_C=100^{\circ}\text{C}$	29	
$I_{DSM}$	Continuous Drain Current <sup>a</sup>	$T_A=25^{\circ}\text{C}$	12	A
		$T_A=70^{\circ}\text{C}$	8.8	
$I_{DM}$	Pulsed Drain Current <sup>b</sup>		215	A
$P_D$	Power Dissipation <sup>c</sup>	$T_C=25^{\circ}\text{C}$	42	W
		$T_C=100^{\circ}\text{C}$	17	
$P_{DSM}$	Power Dissipation <sup>a</sup>	$T_A=25^{\circ}\text{C}$	2.1	W
		$T_A=70^{\circ}\text{C}$	1.3	
$I_{AS}$	Avalanche Current <sup>b</sup> $L=0.5\text{mH}$ Single Pulse		12	A
$E_{AS}$	Avalanche Energy <sup>b</sup> $L=0.5\text{mH}$ Single Pulse		36	mJ
$T_J$	Operation junction temperature		-55~150	$^{\circ}\text{C}$
$T_{STG}$	Storage temperature range		-55~150	

**➤ Thermal Resistance Ratings ( $T_A=25^{\circ}\text{C}$  unless otherwise noted)**

Symbol	Parameter	Ratings	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance <sup>a</sup>	60	$^{\circ}\text{C}/\text{W}$
$R_{\theta JC}$	Junction-to-Case Thermal Resistance	3	

Note:

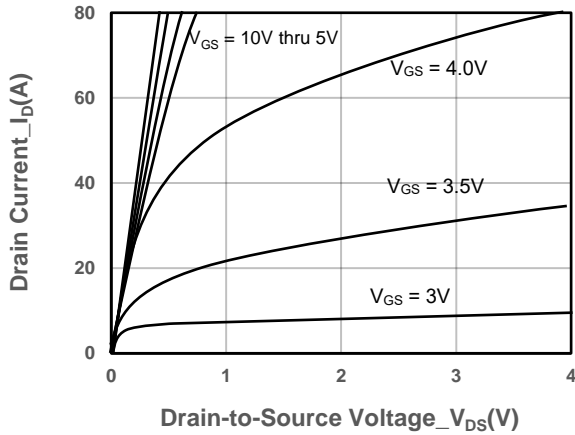
- The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz.copper, in a still air environment with  $T_A=25^{\circ}\text{C}$ . The value in any given application depends on the user is specific board design. The power dissipation is based on the  $t \leq 10\text{s}$  thermal resistance rating.
- Repetitive rating, pulse width limited by junction temperature.
- The power dissipation  $P_D$  is based on  $T_{J(MAX)}=150^{\circ}\text{C}$ , using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- The maximum current rating is package limited.

**➤ Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)**

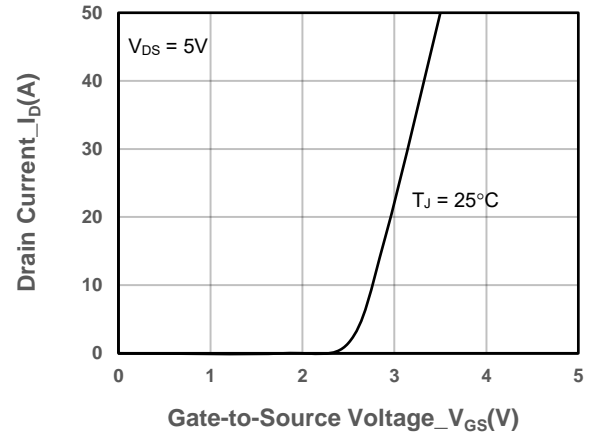
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	40			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250uA	1	1.7	2.5	V
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 12A		9	13	mΩ
		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 10A		12	17	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 40V, V <sub>GS</sub> = 0V			1	μA
Gate-Source Leak Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V			±100	nA
Transconductance	G <sub>FS</sub>	V <sub>DS</sub> = 5V, I <sub>D</sub> = 12A		30		S
Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = 12A		0.8	1.3	V
Gate Resistance	R <sub>G</sub>	V <sub>DS</sub> = 0V, f = 1MHz		1.5		Ω
Input Capacitance	C <sub>ISS</sub>	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V, f = 1MHz		830		pF
Output Capacitance	C <sub>OSS</sub>			340		
Reverse Transfer Capacitance	C <sub>RSS</sub>			7.0		
Total Gate Charge	Q <sub>G</sub>	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 20V, I <sub>D</sub> = 12A		18		nC
Gate to Source Charge	Q <sub>GS</sub>			4.0		
Gate to Drain Charge	Q <sub>GD</sub>			3.6		
Turn-on Delay Time	T <sub>D(ON)</sub>	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 20V, I <sub>D</sub> = 12A, R <sub>G</sub> = 3Ω		7.0		ns
Rise Time	T <sub>r</sub>			3.5		
Turn-off Delay Time	T <sub>D(OFF)</sub>			23		
Fall Time	T <sub>f</sub>			5.6		
Diode Recovery Time	T <sub>rr</sub>	I <sub>F</sub> =12A, di/dt=100A/us		15		ns
Diode Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> =12A, di/dt=100A/us		24		nC



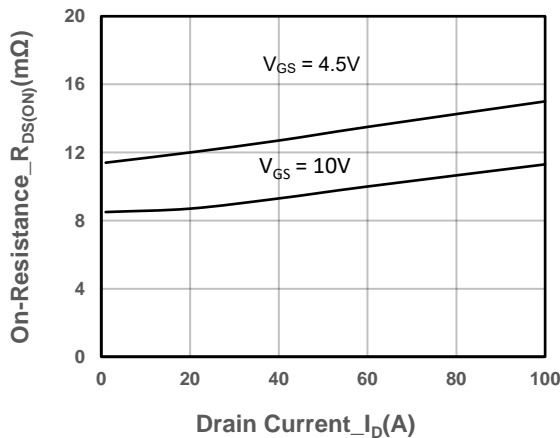
## ➤ Typical Performance Characteristics ( $T_A=25^\circ\text{C}$ unless otherwise noted)



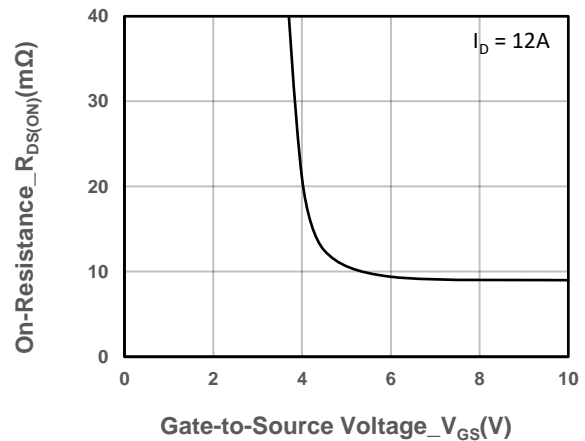
Output Characteristics



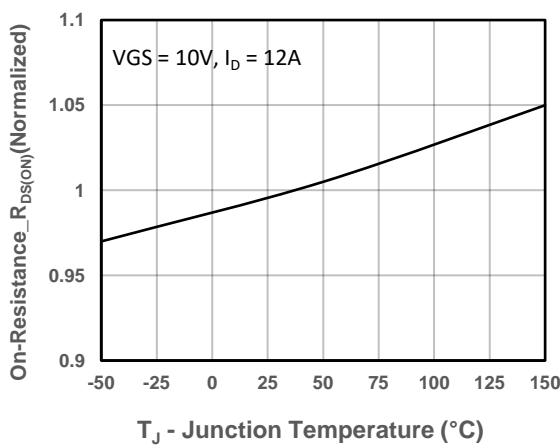
Transfer Characteristics



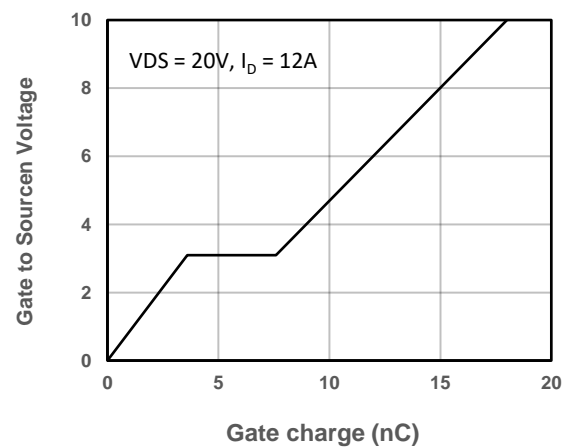
On-Resistance vs. Drain Current and Gate Voltage



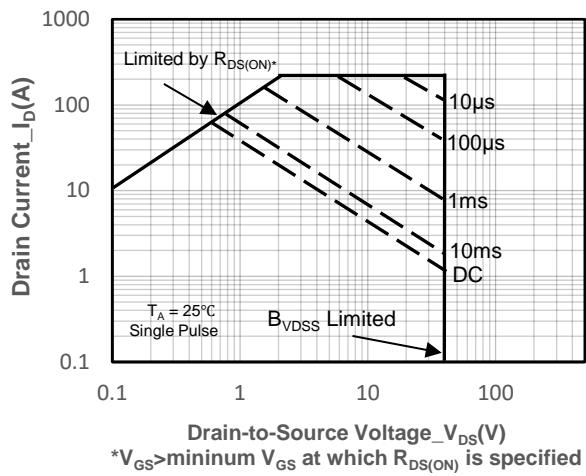
On-Resistance vs. Gate-to-Source Voltage



On-Resistance vs. Junction Temperature



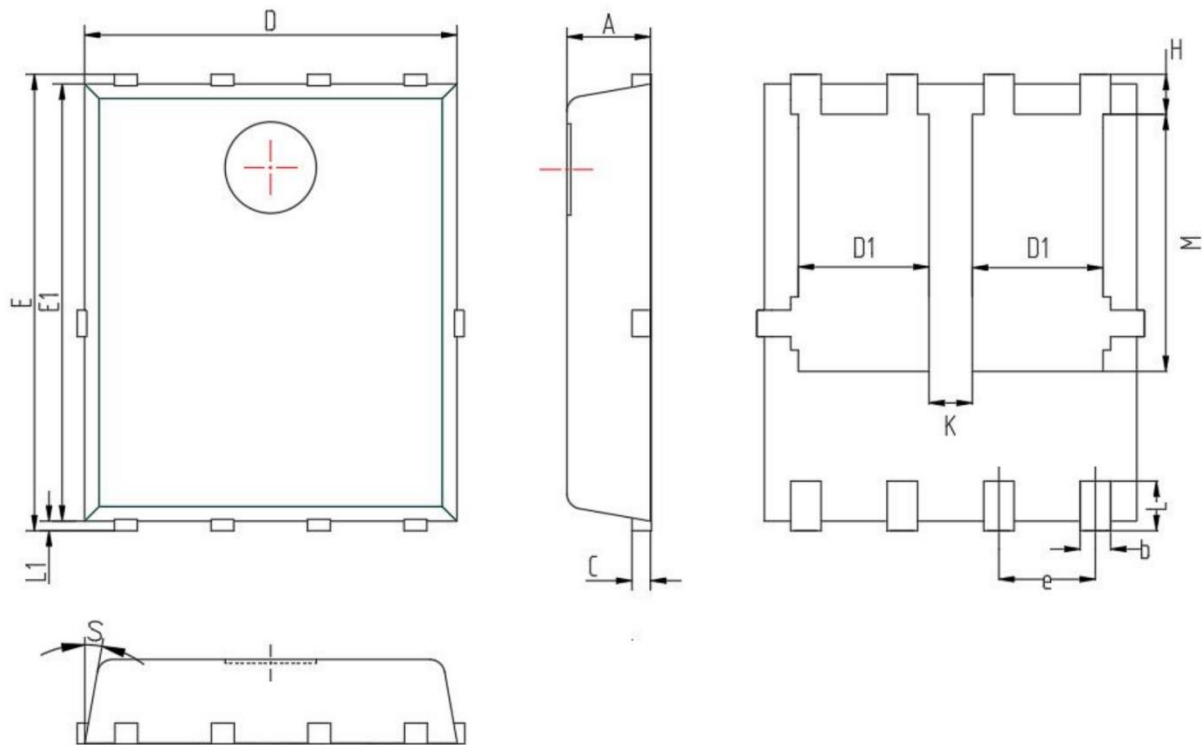
Gate-Source Voltage vs. Gate charge



## Safe Operating Area vs. Junction-to-Ambient



## ➤ Package Information



Symbol	MILL IMETER		
	Min	Nom	Max
A	0.9	1.10	1.20
b	0.25	0.30	0.5
C	0.20	0.25	0.35
D	4.80	5.00	5.20
D1	1.50	1.70	1.80
E	5.90	6.00	6.30
E1	5.60	5.75	5.90
e	1.27BSC		
H	0.48	0.58	0.80
K	0.50	0.60	0.70
L	0.50	0.60	0.84
L1	0.10	0.15	0.30
M	3.30	3.48	3.67
S	12° BSC		



## DISCLAIMER

SSCSEMI RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. SSCSEMI DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENCE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

THE GRAPHS PROVIDED IN THIS DOCUMENT ARE STATISTICAL SUMMARIES BASED ON A LIMITED NUMBER OF SAMPLES AND ARE PROVIDED FOR INFORMATIONAL PURPOSE ONLY. THE PERFORMANCE CHARACTERISTICS LISTED IN THEM ARE NOT TESTED OR GUARANTEED. IN SOME GRAPHS, THE DATA PRESENTED MAY BE OUTSIDE THE SPECIFIED OPERATING RANGE (E.G. OUTSIDE SPECIFIED POWER SUPPLY RANGE) AND THEREFORE OUTSIDE THE WARRANTED RANGE.

OUR PRODUCT SPECIFICATIONS ARE ONLY VALID IF OBTAINED THROUGH THE COMPANY'S OFFICIAL WEBSITE, CRM SYSTEM, OR OUR SALES PERSONNEL CHANNELS. IF CHANGES OR SPECIAL VERSIONS ARE INVOLVED, THEY MUST BE STAMPED WITH A QUALITY SEAL AND MARKED WITH A SPECIAL VERSION NUMBER TO BE VALID.